

(19) World Intellectual Property Organization  
International Bureau



(43) International Publication Date  
5 January 2006 (05.01.2006)

PCT

(10) International Publication Number  
**WO 2006/001611 A1**

(51) International Patent Classification<sup>7</sup>: **H04R 25/00**

(21) International Application Number:  
PCT/KR2005/001697

(22) International Filing Date: 7 June 2005 (07.06.2005)

(25) Filing Language: English

(26) Publication Language: English

(30) Priority Data:  
10-2004-0048723 24 June 2004 (24.06.2004) KR

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(81) Designated States (unless otherwise indicated, for every kind of national protection available): AE, AG, AL, AM,

AT, AU, AZ, BA, BB, BG, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KM, KP, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NA, NG, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RU, SC, SD, SE, SG, SK, SL, SM, SY, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, YU, ZA, ZM, ZW.

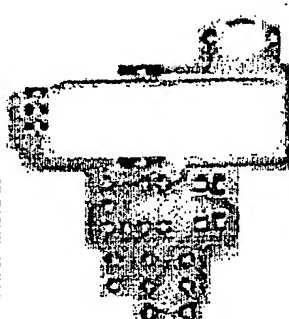
(84) Designated States (unless otherwise indicated, for every kind of regional protection available): ARIPO (BW, GH, GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IS, IT, LT, LU, MC, NL, PL, PT, RO, SE, SI, SK, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).

Published:

— with international search report

For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.

(54) Title: **HEARING AID USING PRINTED CIRCUIT BOARD**



(57) Abstract: A hearing aid using a printed circuit board (PCB) is provided which minimizes internal wires since components of the hearing aid are disposed on the PCB. Since individual soldering of amplifier terminals and components of the hearing aid in an existing hearing aid faceplate manufacturing process which consumes the longest time can be automatically performed on the PCB in which the hearing aid components are automatically soldered and disposed, a total process time can be remarkably shortened.

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